

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

| SUBMISSION TYPE: | NEW ASSIGNMENT | | | | | | | | | | | | |
|---|---|---------------|---|---------------------|---|-------------------|---------------|-------|------------|----------------|----------|--------------|-------|
| NATURE OF CONVEYANCE: | ASSIGNMENT | | | | | | | | | | | | |
| CONVEYING PARTY DATA | | | | | | | | | | | | | |
| <table border="1"> <tr> <th>Name</th> <th>Execution Date</th> </tr> <tr> <td>Kei May LAU</td> <td>01/29/2013</td> </tr> <tr> <td>Chak Wah TANG</td> <td>01/29/2013</td> </tr> </table> | | Name | Execution Date | Kei May LAU | 01/29/2013 | Chak Wah TANG | 01/29/2013 | | | | | | |
| Name | Execution Date | | | | | | | | | | | | |
| Kei May LAU | 01/29/2013 | | | | | | | | | | | | |
| Chak Wah TANG | 01/29/2013 | | | | | | | | | | | | |
| RECEIVING PARTY DATA | | | | | | | | | | | | | |
| <table border="1"> <tr> <td>Name:</td> <td>NANO AND ADVANCED MATERIALS INSTITUTE LIMITED</td> </tr> <tr> <td>Street Address:</td> <td>Rm. 3642, The Hong Kong Jockey Club Enterprise Center, HKUST, Clear Water Bay</td> </tr> <tr> <td>Internal Address:</td> <td>32448U_SNP_dd</td> </tr> <tr> <td>City:</td> <td>Alexandria</td> </tr> <tr> <td>State/Country:</td> <td>VIRGINIA</td> </tr> <tr> <td>Postal Code:</td> <td>22314</td> </tr> </table> | | Name: | NANO AND ADVANCED MATERIALS INSTITUTE LIMITED | Street Address: | Rm. 3642, The Hong Kong Jockey Club Enterprise Center, HKUST, Clear Water Bay | Internal Address: | 32448U_SNP_dd | City: | Alexandria | State/Country: | VIRGINIA | Postal Code: | 22314 |
| Name: | NANO AND ADVANCED MATERIALS INSTITUTE LIMITED | | | | | | | | | | | | |
| Street Address: | Rm. 3642, The Hong Kong Jockey Club Enterprise Center, HKUST, Clear Water Bay | | | | | | | | | | | | |
| Internal Address: | 32448U_SNP_dd | | | | | | | | | | | | |
| City: | Alexandria | | | | | | | | | | | | |
| State/Country: | VIRGINIA | | | | | | | | | | | | |
| Postal Code: | 22314 | | | | | | | | | | | | |
| PROPERTY NUMBERS Total: 1 | | | | | | | | | | | | | |
| <table border="1"> <tr> <th>Property Type</th> <th>Number</th> </tr> <tr> <td>Application Number:</td> <td>13752971</td> </tr> </table> | | Property Type | Number | Application Number: | 13752971 | | | | | | | | |
| Property Type | Number | | | | | | | | | | | | |
| Application Number: | 13752971 | | | | | | | | | | | | |
| CORRESPONDENCE DATA | | | | | | | | | | | | | |
| <p>Fax Number: 7036838396</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 7035486284</p> <p>Email: ddean@nathlaw.com</p> <p>Correspondent Name: NATH, GOLDBERG & MEYER</p> <p>Address Line 1: 112 S. West Street</p> <p>Address Line 2: 32448U_SNP_dd</p> <p>Address Line 4: Alexandria, VIRGINIA 22314</p> | | | | | | | | | | | | | |
| ATTORNEY DOCKET NUMBER: | 32448U_SNP_DD | | | | | | | | | | | | |
| NAME OF SUBMITTER: | Stanley N. Protigal | | | | | | | | | | | | |
| | This document serves as an Oath/Declaration (37 CFR 1.63). | | | | | | | | | | | | |
| <p>Total Attachments: 2</p> <p>source=exeAssig_Lau_Tang#page1.tif</p> <p>source=exeAssig_Lau_Tang#page2.tif</p> | | | | | | | | | | | | | |

OP \$40.00 13752971

DECLARATION UNDER 37 CFR §1.63 AND ASSIGNMENT

32448U

As the undersigned inventor, I hereby declare that this Declaration under 37 CFR §1.63 is directed to the following invention:

Title: **Metamorphic Growth of III-V Semiconductor On Silicon Substrate by MOCVD For High Speed III-V Transistors**

U.S. application serial number or PCT international application number

Filed on

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, **NANO AND ADVANCED MATERIALS INSTITUTE LIMITED**

whose business address is

Room 3641-3649, The Hong Kong Jockey Club Enterprise Center, HKUST, Clear Water Bay, Kowloon
Hong Kong

hereinafter referred to as the ASSIGNEE, desires to acquire the entire right, title and interest for the United States and elsewhere throughout the world in and to said invention and application, including any and all divisions and continuations thereof, all rights of priority under the terms of the International Convention for the Protection of Industrial Property, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof.

NOW, THEREFORE, in consideration of the sum of one dollar (\$1.00) and other good and valuable consideration, the receipt, adequacy and sufficiency of which are hereby acknowledged, the undersigned hereby assigns, sells and transfers to said ASSIGNEE, its assigns and legal representatives, the entire right, title and interest for the United States and elsewhere throughout the world, in and to said invention and application, including any and all divisions and continuations thereof, all rights of priority under the terms of the International Convention for the Protection of Industrial Property, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any way arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives, in as ample and as beneficial a manner for all intents and purposes as the undersigned might or could have held and enjoyed the same had this assignment not been made.

The undersigned hereby agrees to execute all papers necessary to file said applications in the United States and elsewhere throughout the world, and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing any and all Letters Patent thereon. The undersigned authorizes and requests the Commissioner of Patents to issue a Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

I hereby acknowledge that any willful false statement made in this Declaration is punishable under 18 U.S.C. §1001 by fine or imprisonment of not more than five (5) years, or both.

LEGAL NAME OF INVENTOR: **Kei May LAU**

INVENTOR SIGNATURE: _____

DATE: Jan 29, 2013

PATENT

REEL: 030044 FRAME: 0404

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LEGAL NAME OF INVENTOR: **Chak Wah TANG**

INVENTOR SIGNATURE: Wilson Tang

DATE: Jan. 29, 2013

PATENT

RECORDED: 03/19/2013

REEL: 030044 FRAME: 0405